



WTT-D-5-R20_25

Multiple Cards Wrapping Test Tool

Applications

The WTT-D-5-R20_25 is a tool designed to test **at the same** the resistance to static wrapping stress of **10** IC module embedded into ID1 cards format .

- 5 cards on radius 20mm on one side.
- 5 cards on radius 25mm on the other side.

It complies to the latest MasterCard CQM requirements (#8220# test method).

- IC module qualification.
- Smart card Quality control / Production control.
- Durability.

Key benefits

- Flexible test with two radius.



Access



Evolution



Productivity

Technical characteristics

Set of two fixtures

20mm radius
25mm radius

Material

Aircraft grade 6061 aluminum / steel alloy with coating for long-lasting finish

Dimensions

W x D x H: 370 x 300 x 210 mm

Weight

15 kg

In compliance with E.C. directives

Associated products

Other MULANN products are nicely complementary to test the resistance of the IC module on a card body :

- BWT-A control tools for bending stiffness and wrapping stress test
- TFD-A or TFD-P30 testers for dynamic bending and torsion stress test
- T3R-A or T3R-E for three-wheel stress test